# LNJ953W8CRA

# Hight Bright Surface Mounting Chip LED

SV (Side View) Type

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	55	mW	
Forward current	$I_{\mathrm{F}}$	15	mA	
Pulse forward current *	$I_{FP}$	70	mA	
Reverse voltage	V <sub>R</sub>	5	V	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

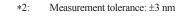
#### ■ Lighting Color

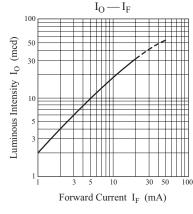
• Blue

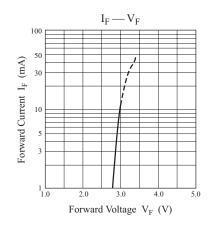
### ■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

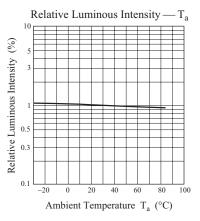
ι α							
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Luminous intensity *1	I <sub>O</sub>	$I_F = 5 \text{ mA}$	7.0	10.0	34.7	mcd	
Reverse current	$I_R$	$V_R = 5 V$			100	μΑ	
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		2.9	3.2	V	
Peak emission wavelength	$\lambda_{\mathrm{P}}$	$I_F = 5 \text{ mA}$		465		nm	
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		20		nm	
Dominant emission wavelength *2	$\lambda_{\mathrm{d}}$	$I_F = 5 \text{ mA}$	462	470	478	nm	

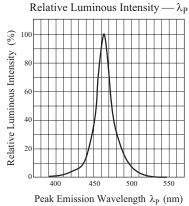
Note) \*1: Measurement tolerance:  $\pm 20\%$ 

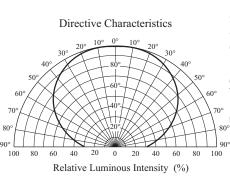


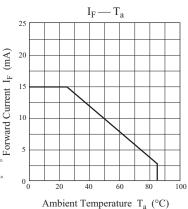








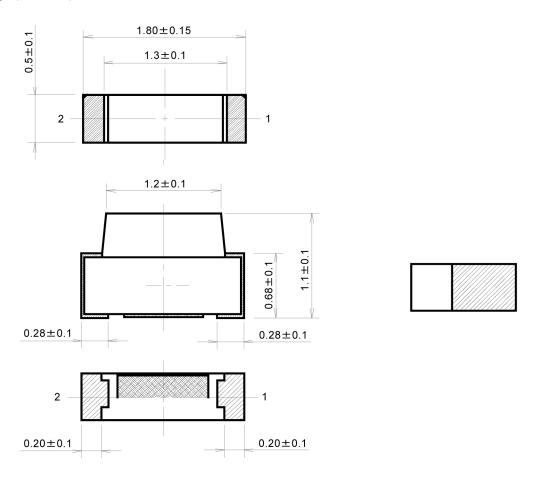




LNJ953W8CRA

**Panasonic** 

## ■ Package (Unit: mm)



- Pin name
  - 1: Anode
  - 2: Cathode

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